### 3.0x2.0mm SURFACE MOUNT LED LAMP

WHITE

### PRELIMINARY SPEC



### ATTENTION

OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

### **Features**

- 3.0MM X 2.0MM, 1.4MM HIGH, ONLY MINIMUM SPACE REQUIRED.
- SUITABLE FOR COMPACT OPTOELECTRONIC APPLICATIONS.
- LOW POWER CONSUMPTION.
- PACKAGE: 2000PCS/REEL.
- MOISTURE SENSITIVITY LEVEL: LEVEL 4.
- ELECTROSTATIC DISCHARGE THRESHOLD (HBM):1000V.
- TYP. COLOR TEMPERATURE: 6500K
- COLOR COORDINATES:X=0.31,Y=0.31 ACC. TO CIE1931(WHITE).
- OPTICAL EFFICIENCY: 51.6 lm/W(TYP.)
- COLOR REPRODUCTION INDEX: 80
- RoHS COMPLIANT.

# Description

Part Number: AA3020ARWC/Z

The source color devices are made with InGaN Light Emitting Diode.

Static electricity and surge damage the LEDS.

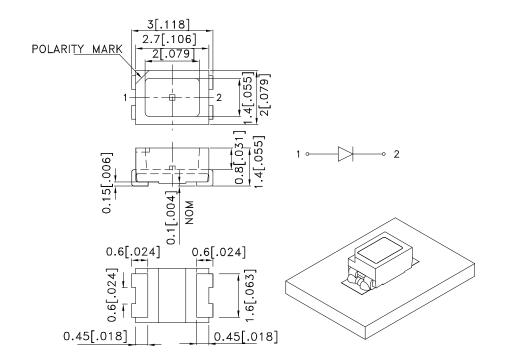
It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

### **Applications**

- · traffic signaling.
- backlighting (illuminated advertising, general lighting).
- interior and exterior automotive lighting.
- substitution of micro incandescent lamps.
- reading lamps.
- signal and symbol luminaire for orientation.
- marker lights (e.g. steps, exit ways, etc).
- · decorative and entertainment lighting.
- indoor and outdoor commercial and residential architectural lighting.

### **Package Dimensions**



### Notes:

- All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25(0.01") unless otherwise noted.
- Specifications are subject to change without notice.
- 4. The device has a single mounting surface. The device must be mounted according to the specifications.





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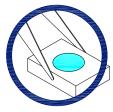
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 CHECKED: Allen Liu
 DRAWN: Y.L.LI
 ERP: 1201003012

### **Handling Precautions**

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

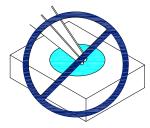
As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.



2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.





3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratch the silicone lens or damage the internal circuitry.



4. During surface-mounting, the pickup capillary diameter should be larger than the silicone lens to insure the capillary does not scratch or damage the lens.



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### **Selection Guide**

Part No.	Dice	Lens Type	luminous Intensity Note2 Iv(mcd) @ 20mA		Lens Type   luminous Intensity Note2   $\Phi v (mlm)$ Note3   $\Phi v (mlm)$   $\Phi v (mlm)$		Viewing Angle Note1
			Min.	Тур.	Min.	Тур.	2 θ 1/2
AA3020ARWC/Z	WHITE (InGaN)	WATER CLEAR	650	1200	1500	3300	120 °

### Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Value	Unit
Power dissipation	Pt	111	mW
Reverse Voltage	VR	5	V
Junction temperature	TJ	110	°C
Operating Temperature	Тор	-40 To +85	°C
Storage Temperature	Tstg	-40 To +100	°C
DC Forward Current	lF	30	mA
Peak Forward Current Note4	IFM	100	mA
Thermal resistance Junction/ambient Note5 Junction/solder point	Rth JA Rth JS	300 140	°C/W °C/W

### Notes:

- $1.0 \frac{1}{2}$  is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
- 2.Luminous intensity is measured by a current pulse of 10ms at a tolerance of ±15%.
- 3.The typical data of Luminous Flux can only reflect statistical figures, actual parameters of individual product could differ from the typical data. For the purpose of product enhancement, the typical data is subject to change without prior notice.
- 4.1/10 Duty Cycle, 0.1ms Pulse Width.
- 5.Rth(J-A) Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad),

### Electrical / Optical Characteristics at TA=25°C

Parameter	Symbol	Value	Unit
Chromaticity coordinate x acc.to CIE1931 IF=20mA [Typ.]	X Note1	0.31	-
Chromaticity coordinate y acc.to CIE1931 IF=20mA [Typ.]	Y Note1	0.31	-
Forward Voltage IF=20mA [Min.]		2.7	
Forward Voltage IF=20mA [Typ.]	V <sub>F</sub> Note2	3.2	V
Forward Voltage IF=20mA [Max.]		3.7	
Reverse Current (VR=5V) [Typ.]	l <sub>R</sub>	0.01	^
Reverse Current (VR=5V) [Max.]	- IR	10	μΑ
Temperature coefficient of x IF=20mA, -10 ° C≤ T≤100 ° C [Typ.]	TCx	-0.1	10 <sup>-3</sup> /° C
Temperature coefficient of y IF=20mA, -10 $^{\circ}$ C $\leq$ T $\leq$ 100 $^{\circ}$ C [Typ.]	ТСу	-0.2	10 <sup>-3</sup> /° C
Temperature coefficient of VF IF=20mA, -10 $^{\circ}$ C $\leq$ T $\leq$ 100 $^{\circ}$ C [Typ.]	TCv	-2.5	mV/° C

### Notes

- 1.Chromaticity coordinates are measured by a current pulse of 20ms with a tolerance of ±0.01 in X and Y color coordinates.
- 2. Forward voltage is measured with a current pulse of 10ms at a tolerance of ±0.1V.

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### **Brightness codes**

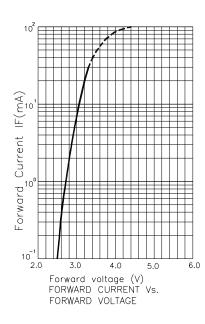
luminous Intensity <sup>Note1</sup> Iv(mcd) @ 20mA			Φν (mlm) <sup>Note2</sup> @ 20mA
Code.	Min.	Max.	Тур.
Т	650	1200	3260
U	900	1500	3350
V	1200	1800	3400

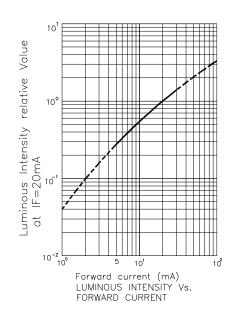
### Notes:

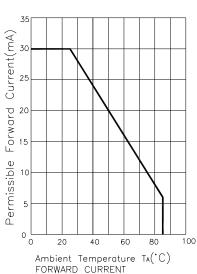
- 1.Luminous intensity is measured by a current pulse of 10ms at a tolerance of ±15%.
- 2. The typical data of Luminous Flux can only reflect statistical figures, actual parameters of individual product could differ from the typical data. For the purpose of product enhancement, the typical data is subject to change without prior notice.

### White

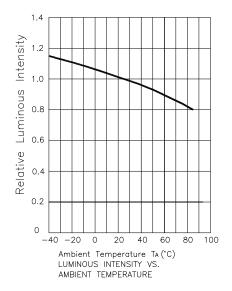
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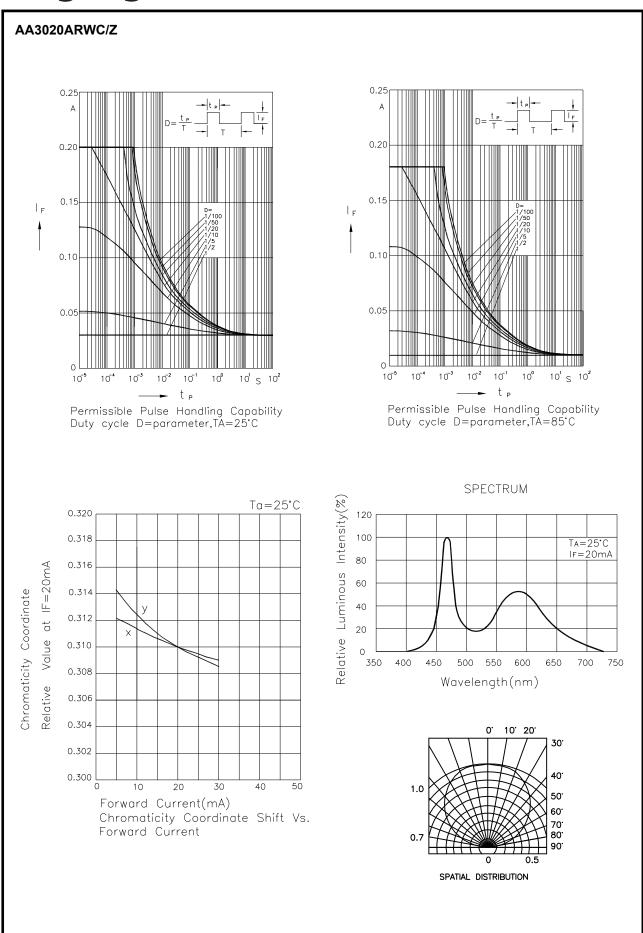




DERATING CURVE



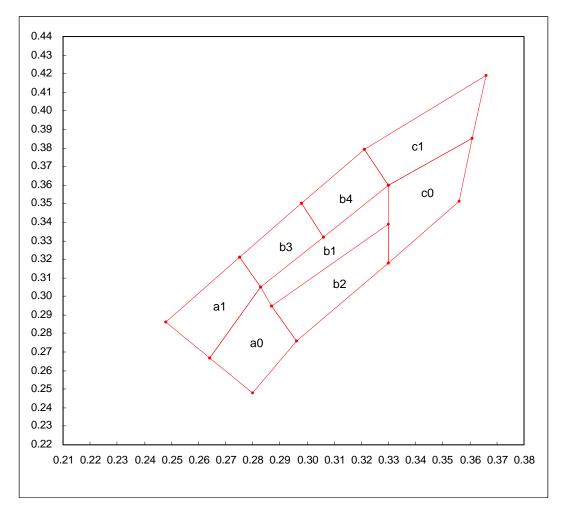
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### AA3020ARWC/Z

### White CIE



a0					
Х	0.264	0.283	0.296	0.280	
Y	0.267	0.305	0.276	0.248	
Reference CCT: 14000~9000k					

a1					
Х	0.248	0.275	0.283	0.264	
Y	0.286	0.321	0.305	0.267	
Reference CCT: 14000~9000k					

		b1		
Х	0.283	0.330	0.330	0.287
Υ	0.305	0.360	0.339	0.295
Reference CCT: 9000~5600k				

b2					
Х	0.287	0.330	0.330	0.296	
Υ	0.295	0.339	0.318	0.276	
Reference CCT: 9000~5600k					

		b3			
Х	0.275	0.298	0.306	0.283	
Υ	0.321	0.350	0.332	0.305	
Reference CCT: 9000~7000k					

b4					
Х	0.298	0.321	0.330	0.306	
Υ	0.350	0.379	0.360	0.332	
Reference CCT: 7600~5600k					

		c0		
Х	0.330	0.361	0.356	0.330
Y	0.360	0.385	0.351	0.318
Reference CCT: 5600~4600k				

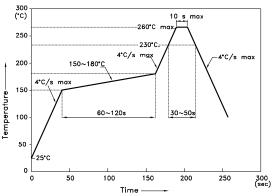
		c1		
Х	0.321	0.366	0.361	0.330
Υ	0.379	0.419	0.385	0.360
Reference CCT: 6000~4600k				

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Reflow Soldering Profile For Lead-free SMT Process.



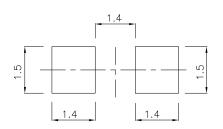
NOTES:

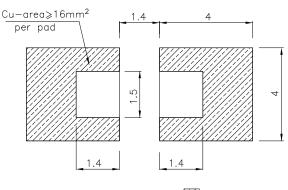
- T.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- to high temperature.

  3.Number of reflow process shall be 2 times or less.

## Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

Pad design for improved heat dissipation





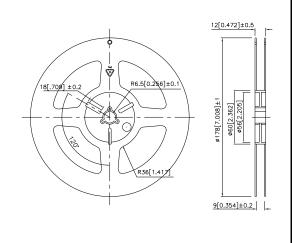
### Solder resist

### **Tape Specifications**

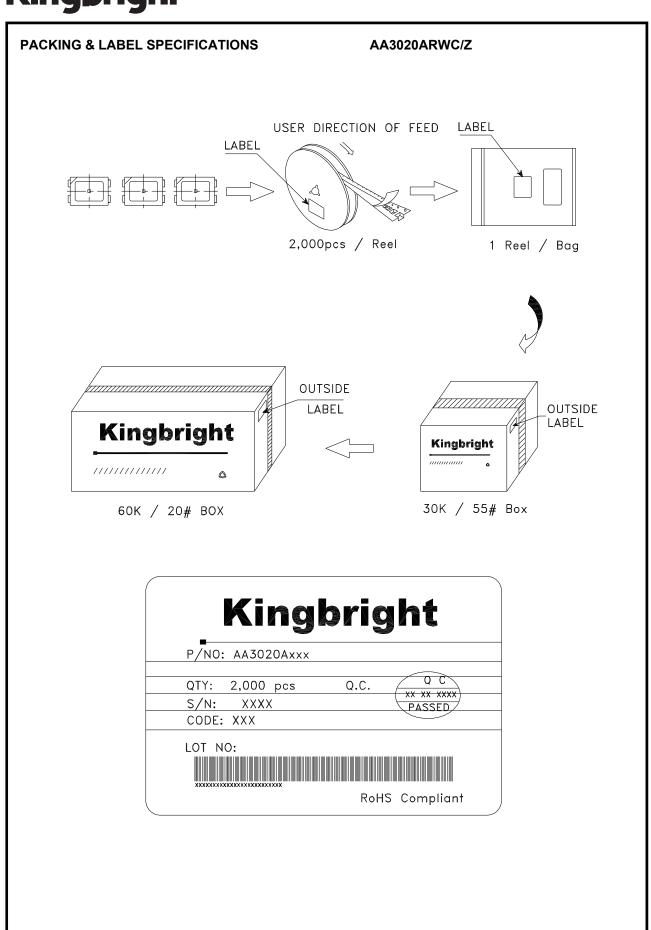
(Units: mm)

# TAPE 4.0±0.1 2.0±0.05 4.0±0.1 1.65±0.1 1.65±0.1 2.25±0.1 3.5°MAX. A-A SECTION

### **Reel Dimension**



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